

BOM:

1	Usb 3.0-A母座(dip)沉板式-上座	短端子	DP0001012002-3XXY	DP0001012002-5XX	PHOSPHOR BRONZE(C5191R-H) T=0.20mm	SEE TABLE1 鍍底30U"Min	4	衝壓
2	Usb 3.0-A母座(dip)沉板式-下座	長端子	DP0001012002-2XXY	DP0001012002-4XX	BRASS(C2680R-H) T=0.20mm	SEE TABLE1 鍍底30U"Min	5	衝壓
3	Usb 3.0-A母座(dip)沉板式-外殼		DP0001012002-1		LCP(E6808)(無齒) UL94 V-0	SEE TABLE2	1	注塑
4					LCP(E6808)(無齒) UL94 V-0	SEE TABLE2	1	注塑
5					STAINLESS STEEL(201) T=0.30mm	吃錫鍍	1	衝壓
項次	名稱		料號		材質	電鍍(或顏色)	數量	備註

 東莞世華電子有限公司 SHYH HWA ELECTRONICS CO.,LTD.(DONGGUAN) 地址:東莞市塘廈鎮諸佛嶺178工業區 TEL:0769-87910020-1 FAX:0769-87910210	DRAWN BY	胡久量	ITEM	Usb 3.0-A母座(DIP)沉板式		ANGLE PROJECTION	UNIT	mm
	CHECKED BY						SCALE	1:1
	APPROVED BY		PART NO	DP0001012002-XXY-WLE294	TOLERANCE	.X±0.25 .XX±0.15	DATE	07/16/2013

REV	DESCRIPTION	ECN/ECR	DATE	DRAWN BY
△A0	新訂圖面		05/28/2012	胡久量
△A1	修改電鍍要求	ECR	06/20/2012	胡久量
△A2	修改料號	ECR	07/02/2012	胡久量
△A3	修改尺寸	ECR	03/18/2012	彭志婷
△A4	修改實物一致	ECR	07/16/2013	胡久量

NOTES:

1.ELECTRICAL CHARACTERISTICS:

1.1 CONTACT CURRENT RATING:1.80A FOR VBUS AND GND
0.25A FOR ALL OTHERS CONTACT

1.2 INSULATION RESISTANCE:100 MEGAOHMS MIN AT 250 VDC

1.3 DIELECTRIC WITHSTANDING VOLTAGE:500 VAC MIN

1.4 LOW LEVEL CONTACT RESISTANCE:30mΩ MAX FOR VBUS AND PGND.
50mΩ MAX FOR OTHER CONTACTS.

2.MECHANICA CHARACTERISTIC:

2.1 INSERTION FORCE:35N MAX

2.2 EXTRACTION FORCE:10N MIN FOR INITIAL.
8N MIN FOR AFTER TEST

2.3 DURABILITY:5,000 MATING CYCLES

2.4 OPERATING TEMPERATURE:-55°C TO +85°C

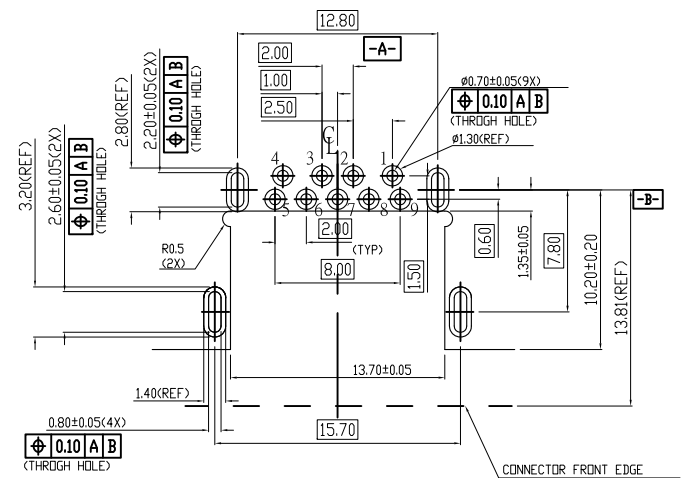


TABLE1:

XX	PLATING
01	G.F./50U"Min TIN PLATED(霧錫)
02	3U"G./50U"Min TIN PLATED(霧錫)
03	5U"G./50U"Min TIN PLATED(霧錫)
04	10U"G./50U"Min TIN PLATED(霧錫)
05	15U"G./50U"Min TIN PLATED(霧錫)
06	30U"G./50U"Min TIN PLATED(霧錫)

TABLE2:

Y	COLOR
01	BLACK
02	BLUE(PANTONE 300C)